



#### **Product Description**

he PE9309 is a high-performance dynamic UltraCMOS<sup>®</sup> prescaler with a fixed divide ratio of 4. Its operating frequency range is 3.0 GHz to 13.5 GHz. The PE9309 operates on a single supply with a frequency-selecting bias resistor and draws only 16 mA. It is packaged in a small 8-lead CFP and is also available in Die form for hybrid application.

The PE9309 is manufactured on Peregrine's UltraCMOS process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

# **Product Specification**

## PE9309

3.0–13.5 GHz Low Power UltraCMOS<sup>®</sup> Divide-by-4 Prescaler Radiation Tolerant for Space Applications

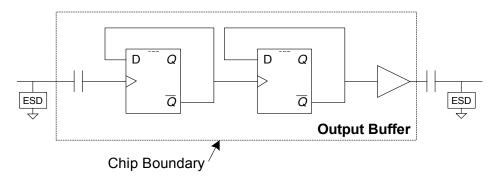
#### Features

- High-frequency operation: up to 13.5 GHz
- Fixed divide ratio of 4
- Low-power operation:16 mA typical @ 2.6V
- Small package: 8-lead CFP
- Available as DIE

#### Figure 2. Package Type 8-lead CFP



#### Figure 1. Functional Schematic Diagram

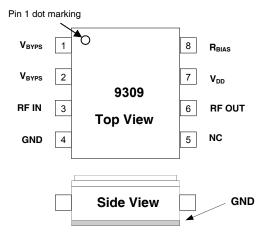


#### Table 1. Electrical Specifications (Z<sub>S</sub> = Z<sub>L</sub> = 50 $\Omega$ ) –40 °C $\leq$ T<sub>A</sub> $\leq$ +85 °C, unless otherwise specified

Parameter	Condition	Min	Тур	Мах	Unit
Frequency		3.0		13.5	GHz
Output power, P <sub>out</sub>	$0.75 \text{ GHz} \leq F_{OUT} \leq 3.375 \text{ GHz}$	0			dBm
Input power, P <sub>IN</sub>	$3.0 \text{ GHz} \leq F_{\text{IN}} < 13.5 \text{ GHz}$	0		7	dBm



#### Figure 3. Pin Configuration (Top View)



#### Table 2. Pin Descriptions

Pin #	Pin Name	Description
1	VBYPS	Prescaler supply bypass
2	VBYPS	Prescaler supply bypass
3	IN	RF input
4	GND	Ground
5	NC	Not connected
6	OUT	RF output
7	V <sub>DD</sub>	Supply voltage
8	R <sub>BIAS</sub>	Frequency-selecting bias resistor
GND	GND	Bottom of the package is ground. Connecting the bottom of the package to ground is required

#### Table 3. Operating Ranges

Parameter	Min	Тур	Max	Unit
Supply voltage, V <sub>DD</sub>	2.45	2.6	2.75	V
Supply current, I <sub>DD</sub>	6		23	mA

Symbol	Parameter/Condition		Max	Unit
V <sub>DD</sub>	DC supply voltage		3.0	V
T <sub>ST</sub>	Storage temperature range	-65	150	°C
T <sub>OP</sub>	Operating temperature range	-40	85	°C
V <sub>ESD</sub>	ESD voltage (Human Body Model)		250	V
P <sub>IN_MAX</sub>	Maximum input power		14	dBm

#### **Table 4. Absolute Maximum Ratings**

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

#### **Electrostatic Discharge (ESD) Precautions**

When handling this UltraCMOS device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

#### Latch-Up Immunity

Unlike conventional CMOS devices, UltraCMOS devices are immune to latch-up.

#### ELDRS

UltraCMOS devices do not include bipolar minority carrier elements, and therefore do no exhibit enhanced low dose rate sensitivity.





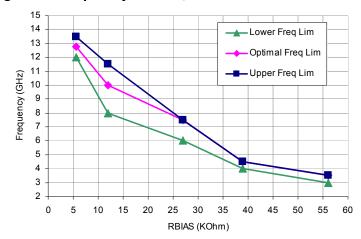
#### **Device Functional Considerations**

The PE9309 divides a 3.0 GHz to 13.5 GHz input signal by four, producing a 750 MHz to 3.375 GHz output signal. In order for the prescaler to work properly, several conditions need to be adhered to. It is crucial that pins 1, 2 and 7 be supplied with bypass capacitors to ground. In addition, the output signal (pin 6) needs to be ac coupled via an external capacitor as shown in the test circuit in *Figure 5*.

The input frequency range is selected by the value of  $R_{BIAS}$  according to *Figure 4*.

The ground pattern on the board should be made as wide as possible to minimize ground impedance.

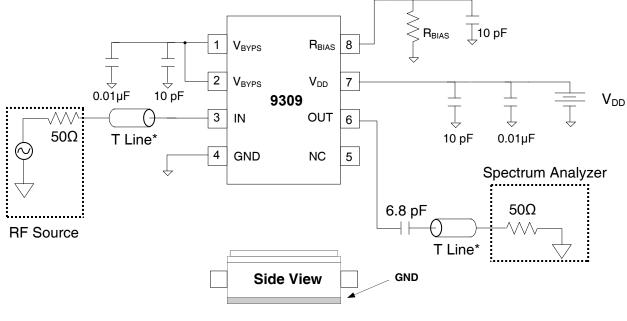
The bottom of the package is the primary ground connection and it needs to be soldered to the PCB ground.



#### Figure 4. Frequency vs R<sub>BIAS</sub>



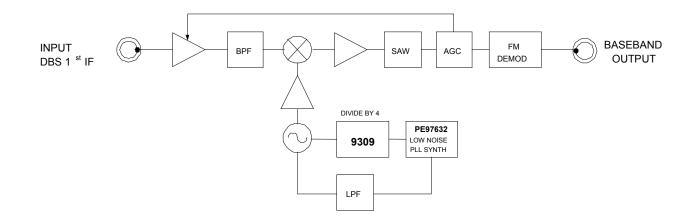
#### Figure 5. Test Circuit Block Diagram



\*T Line = Transmission Line

#### Figure 6. High Frequency System Application

The wideband frequency of operation of the PE9309 makes it an ideal part for use in a DBS down converter system.



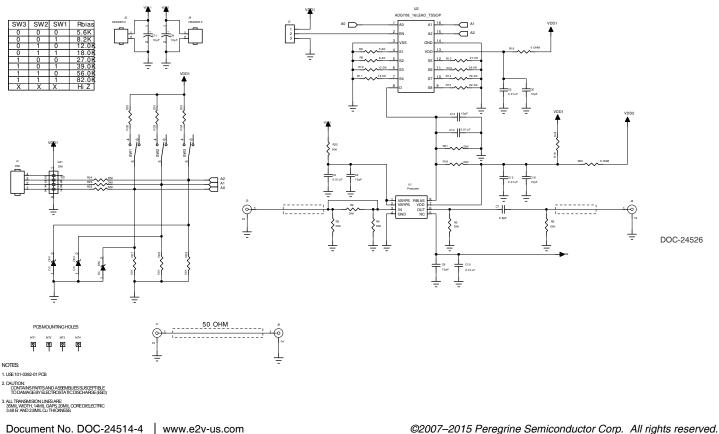


### **Evaluation Kit**

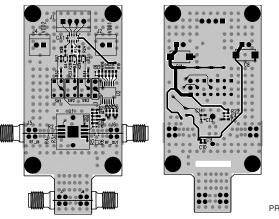
The ceramic CFP prescaler evaluation board was designed to help customers evaluate the PE9309 divide-by-4 prescaler. On this board, the device input (pin 3) is connected to the SMA connector J5 through a 50 $\Omega$  transmission line. The device output (pin 6) is connected to SMA connector J6 through a 50 $\Omega$  transmission line.

J4 provides DC power to the device via pin 7. J2 powers U2. Multiple decoupling capacitors (C4, 6, 13, 16 = 10pF, C3, 5, 14, 15 = 0.01uF) are used. One out of eight different resistors for R<sub>BIAS</sub> is selected by toggling SW1, SW2 and SW3 according to the table shown in *Figure 8*. Jumper on J3 should be on to lower setting (1 and 2). It is the responsibility of the customer to determine proper supply decoupling for their design application. The board is constructed using 4 layers. The top and bottom layers comprise Rogers low loss 4350 material having a core thickness of 0.010" while the internal layers comprise FR-4. The overall board thickness is 0.062".

#### Figure 8. Evaluation Board Schematic



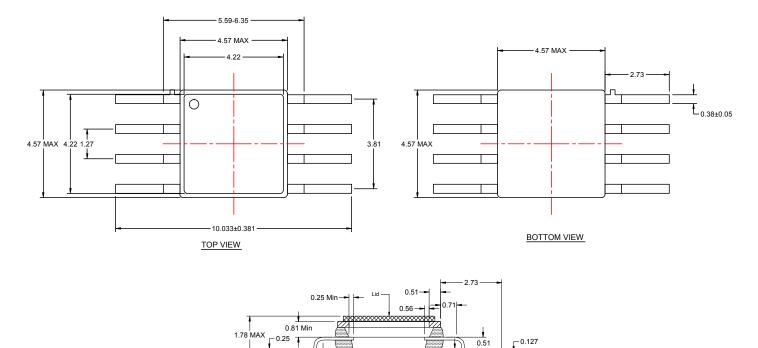
#### Figure 7. Evaluation Board Layouts



PRT-17605



# Figure 9. Package Drawing 8-lead CFP



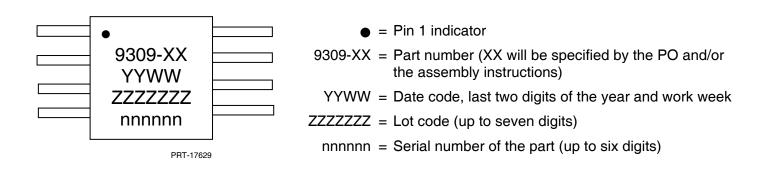
0.32

0.254±0.05-

Side View

1.70 MIN

Figure 10. Top Marking Specifications



DOC-50608



#### **Table 5. Ordering Information**

Order Code	Description	Package	Shipping Method
9309–01*	PE9309–08CFPJ–B Engineering samples	8-lead CFP	50 / Tray
9309–11	PE9309–08CFPJ–B Production units	8-lead CFP	50 / Tray
9309–00	PE9309 Evaluation kit	Evaluation kit	1 / Box

Note: \* The 9309-01 devices are engineering sample (ES) prototype units intended for use as initial evaluation units for customers of the PE9309-11 flight units. The PE9309-01 device provides the same functionality and footprint as the PE9309-11 space qualified device, and intended for engineering evaluation only. They are tested at +25 °C only and processed to a non-compliant flow (e.g. no burn-in, non-hermetic, etc). These units are non-hermetic and are not suitable for qualification, production, radiation testing or flight use.

#### Sales Contact and Information

<u>Contact Information:</u> e2v ~ <u>http://www.e2v-us.com</u> ~ inquiries@e2v-us.com

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